

**General Description**

The SJD02N5000 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 10V. This device is suitable for use as a wide variety of applications.

Features

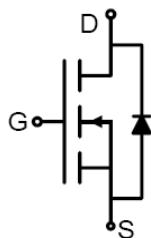
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

Application

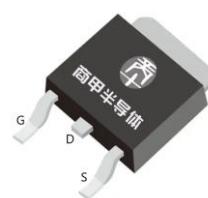
- Power switching application
- Hard switched and high frequency circuits

Key Performance Parametes

Parameter	Value	Unit
V_{DS}	200	V
$R_{DS(ON)}_{TYP}$	481	$m\Omega$
I_D	6.3	A
Q_G	12.8	nC



Schematic Diagram



TO-252 top view

Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJD02N5000	D02N5000	TO-252	Tape	\	\	2500 Pcs

Table 1. Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

Symbol	Parameter	Limit	Unit
V_{DS}	Drain-Source Voltage ($V_{GS}=0V$)	200	V
V_{GS}	Gate-Source Voltage ($V_{DS}=0V$)	± 20	V
I_D	Drain Current-Continuous($T_c=25^\circ C$)	6.3	A
	Drain Current-Continuous($T_c=100^\circ C$)	4	A
I_{DM} (pulse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	25.2	A
P_D	Maximum Power Dissipation($T_c=25^\circ C$)	60	W
	Maximum Power Dissipation($T_c=100^\circ C$)	23.8	W
E_{AS}	Avalanche energy (Note 2)	10.6	mJ
T_J, T_{STG}	Operating Junction and Storage Temperature Range	-55 To 150	°C

Table 2. Thermal Characteristic

Symbol	Parameter	Typ	Max	Unit
R_{eJC}	Thermal Resistance, Junction-to-Case		2.1	°C/W



200V N-Channel Trench Power MOSFET

Table 3. Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
On/Off States						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ $I_{\text{D}}=250\mu\text{A}$	200			V
$I_{\text{DS}}^{\text{SS}}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=200\text{V}$, $V_{\text{GS}}=0\text{V}$ $T_J=25^\circ\text{C}$			1	μA
		$V_{\text{DS}}=200\text{V}$, $V_{\text{GS}}=0\text{V}$ $T_J=125^\circ\text{C}$			100	μA
I_{GSS}	Gate-Body Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$			± 100	nA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_{\text{D}}=250\mu\text{A}$	1		3	V
g_{FS}	Forward Transconductance	$V_{\text{DS}}=10\text{V}$, $I_{\text{D}}=20\text{A}$		8		S
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=10\text{V}$, $I_{\text{D}}=2\text{A}$ $T_J=25^\circ\text{C}$		481	578	$\text{m}\Omega$
$R_{\text{DS(ON)}}$	Drain-Source On-State Resistance	$V_{\text{GS}}=4.5\text{V}$, $I_{\text{D}}=2\text{A}$ $T_J=25^\circ\text{C}$		488	649	$\text{m}\Omega$
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{\text{DS}}=25\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1.0\text{MHz}$		775		pF
C_{oss}	Output Capacitance			12.5		pF
C_{rss}	Reverse Transfer Capacitance			4.4		pF
R_g	Gate resistance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=0\text{V}$, $f=1.0\text{MHz}$		1.4		Ω
Switching Parameters						
$t_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=100\text{V}$, $R_L=25\Omega$, $R_{\text{GEN}}=5\Omega$		13		nS
t_r	Turn-on Rise Time			10		nS
$t_{\text{d(off)}}$	Turn-Off Delay Time			40		nS
t_f	Turn-Off Fall Time			9		nS
Q_g	Total Gate Charge	$V_{\text{GS}}=10\text{V}$, $V_{\text{DS}}=100\text{V}$, $I_{\text{D}}=4\text{A}$		12.8		nC
Q_{gs}	Gate-Source Charge			2.1		nC
Q_{gd}	Gate-Drain Charge			2.2		nC
Source-Drain Diode Characteristics						
I_{SD}	Source-Drain Current (Body Diode)				6.3	A
V_{SD}	Forward on Voltage (Note 3)	$V_{\text{GS}}=0\text{V}$, $I_{\text{S}}=4\text{A}$			1.2	V
t_{rr}	Reverse Recovery Time	$I_F=4\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$		86		ns
Q_{rr}	Reverse Recovery Charge	$I_F=4\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$		290		nC

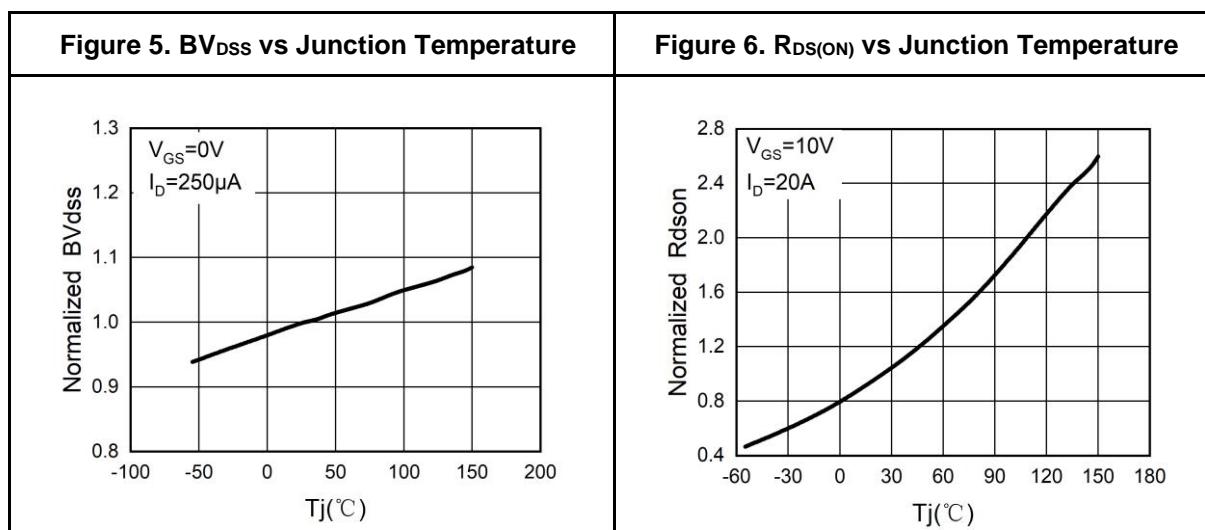
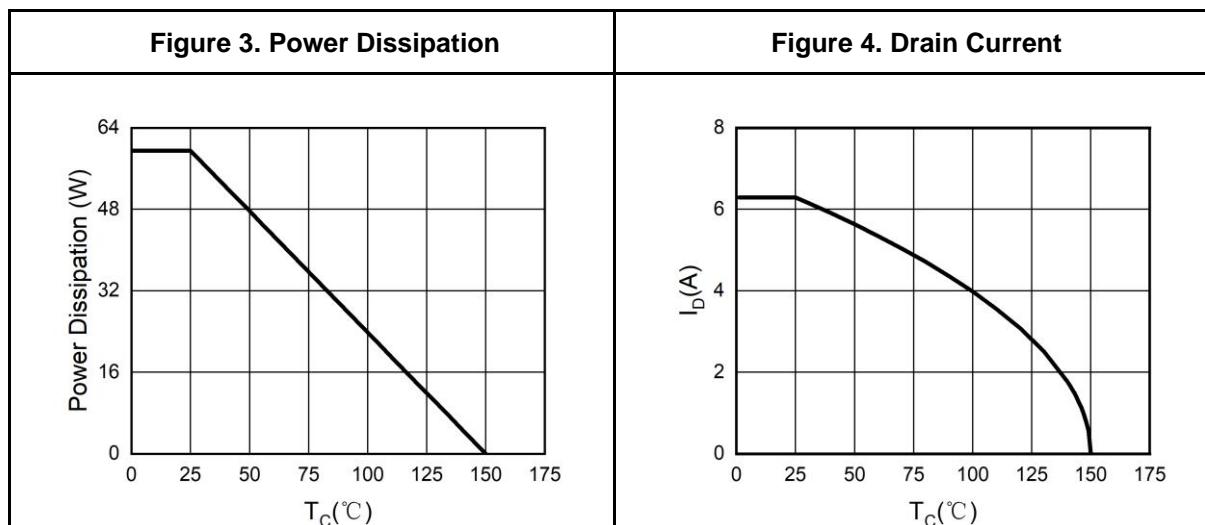
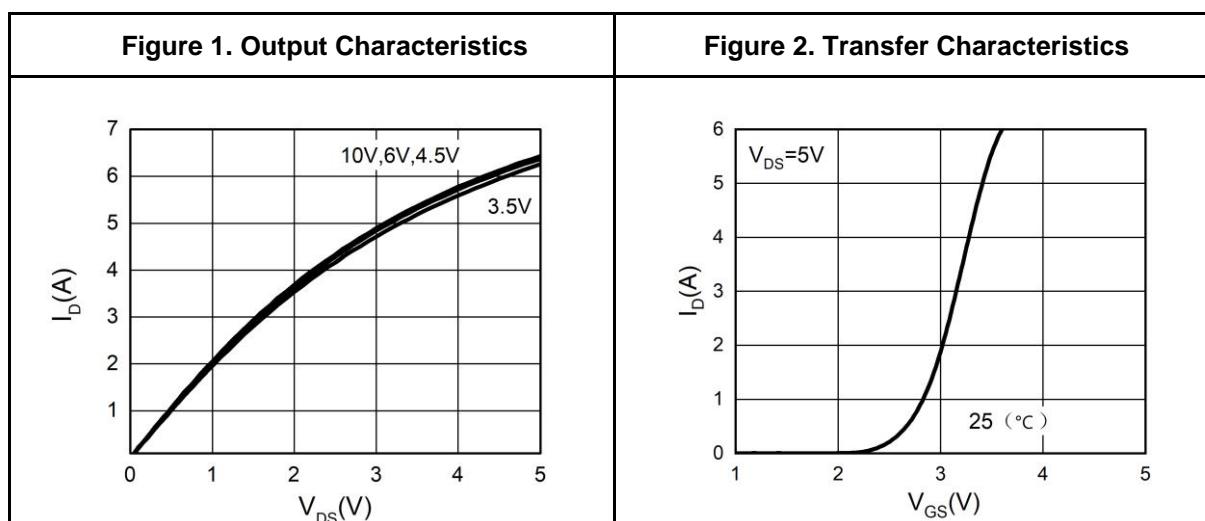
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

Notes 2.E_{AS} condition: $T_J=25^\circ\text{C}$, $V_{\text{DD}}=60\text{V}$, $V_G=10\text{V}$, $R_g=25\Omega$, $L=0.5\text{mH}$.

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

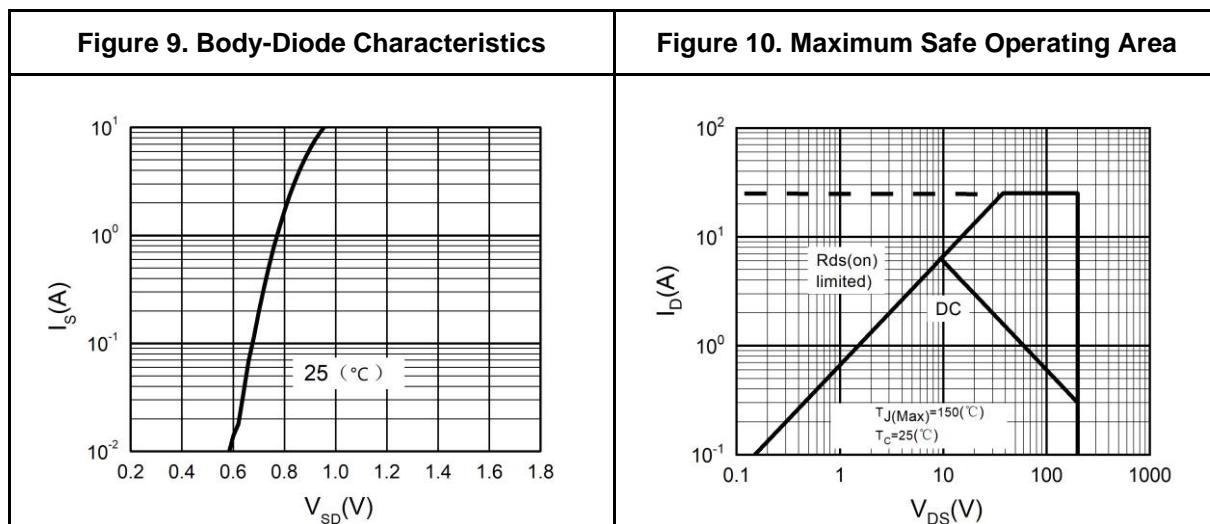
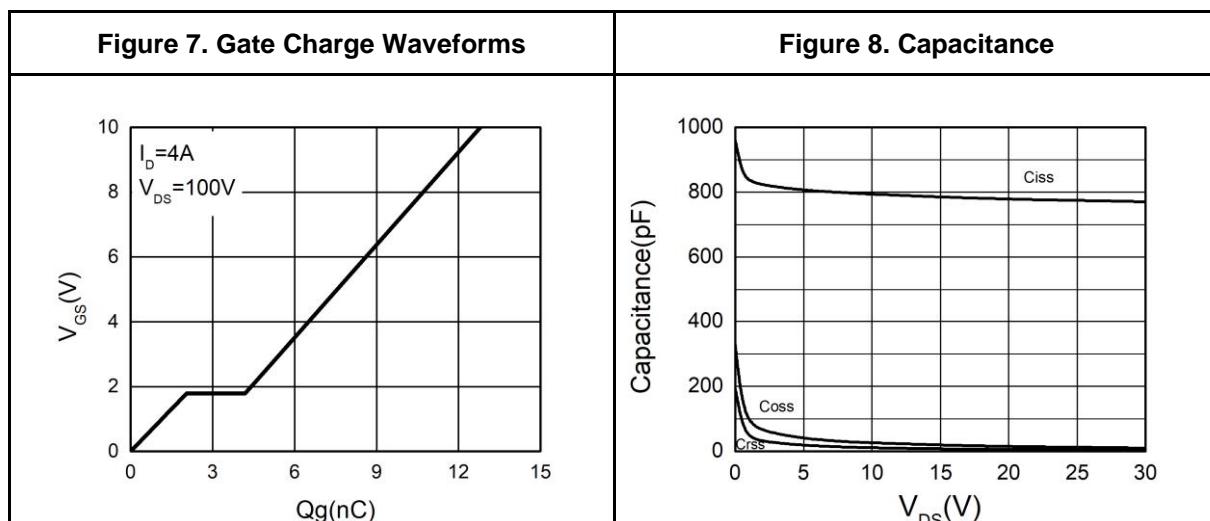


Typical Electrical And Thermal Characteristics (Curves)



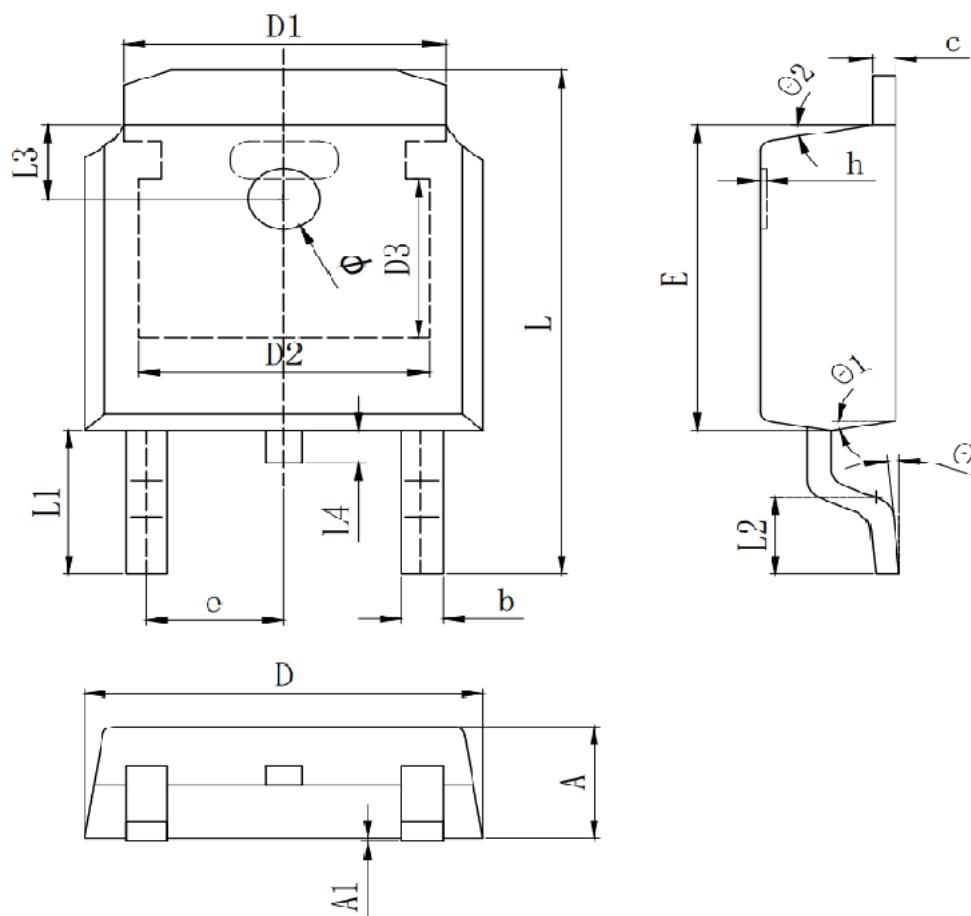


Typical Electrical And Thermal Characteristics (Curves)





TO-252 Package Information



Symbol	Dimensions In Millimeters		
	Min.	Typ.	Max.
A	2.200	2.300	2.400
A1	0.000		0.127
b	0.640	0.690	0.740
c(电镀后)	0.460	0.520	0.580
D	6.500	6.600	6.700
D1		5.334 REF	
D2		4.826 REF	
D3		3.166 REF	
E	6.000	6.100	6.200
e		2.286 TYP	
h	0.000	0.100	0.200
L	9.900	10.100	10.300
L1		2.888 REF	
L2	1.400	1.550	1.700
L3		1.600 REF	
L4	0.600	0.800	1.000
Φ	1.100	1.200	1.300
θ	0°		8°
θ1		9° TYP	
θ2		9° TYP	



Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

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